Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TAE KYUNG WON	09/03/2008
SOO YOUNG CHOI	09/03/2008
DONG-KIL YIM	09/04/2008
JRIYAN JERRY CHEN	09/03/2008

RECEIVING PARTY DATA

Name:	APPLIED MATERIALS, INC.	
Street Address:	reet Address: P.O. BOX 450A	
Internal Address:	LEGAL AFFAIRS DEPT.	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95052	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12204563

CORRESPONDENCE DATA

Fax Number: (408)986-3090

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 408-563-2726

Email: robert_mulcahy@contractor.amat.com

Correspondent Name: Robert W. Mulcahy
Address Line 1: P.O. BOX 450A

Address Line 2: LEGAL AFFAIRS DEPT.

Address Line 4: SANTA CLARA, CALIFORNIA 95052

ATTORNEY DOCKET NUMBER: AM13207/DISPLAY/ESONG

NAME OF SUBMITTER: ROBERT W MULCAHY

PATENT REEL: 021484 FRAME: 0296

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Total Attachments: 4

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ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1)	TAE KYUNG WON 1054 Belvedere Lane San Jose, CA 95129	2)	SOO YOUNG CHOI 40907 Rioja Court Fremont, CA 94539
3)	DONG-KIL YIM #310-1101 Halla Apt. Cheongsol-Maeul Keumgok-Dong Pundang-Ku Sungnam-City, Kyunggi-Do 463-725 KOREA	4)	JRIYAN JERRY CHEN 3825 Pruneridge Avenue Santa Clara, CA 95051

(hereinafter referred to as Assignors), have invented a certain invention entitled:

MICROCRYSTALLINE SILICON THIN FILM TRANSISTOR

	end	closed	herewith or for v	which ap	plication	າ for	Letters !	Patent in	the	United S	Stat	es
was	filed	on _		_, unde	Serial	No.				execute	ed	on
ever	date	herev	vith; and									

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all 833023

Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

- Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	9/3/08 (DATE)	Teplan
2)	9/3/0f (DATE)	TAE KYUNG WON
3)	(DATE)	SOO YOUNG CHOI
4)	9/3/08 (DATE)	DONG-KIL YIM
,	(,	JRIYAN JERRY CHEN

833023 2 of 2

ASSIGNMENT FOR APPLICATION FOR PATENT

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Names and Addresses of Inventors:

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3)	DONG-KIL YIM #403-502 Sinsung APT, Sunae-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, South Korea, 463-779	4)	JRIYAN JERRY CHEN 3825 Pruneridge Avenue Santa Clara, CA 95051

(hereinafter referred to as Assignors), have invented a certain invention entitled:

MICROCRYSTALLINE SILICON THIN FILM TRANSISTOR

	enclosed herewith or for	which app	lication for	Letters	Patent in	the	United Sta	ites
was	filed on	, under	Serial No.				executed	on
even	date herewith; and							

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

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including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

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1)	(DATE)	
	· · · · · · · · · · · · · · · · · · ·	TAE KYUNG WON
2)	(DATE)	
		SOO YOUNG CHOI
3)	Sept 4, 2008 (DATE)	2/01/4
		DONG-KIL YIM
4)	(DATE)	
	en e	JRIYAN JERRY CHEN

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RECORDED: 09/04/2008

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